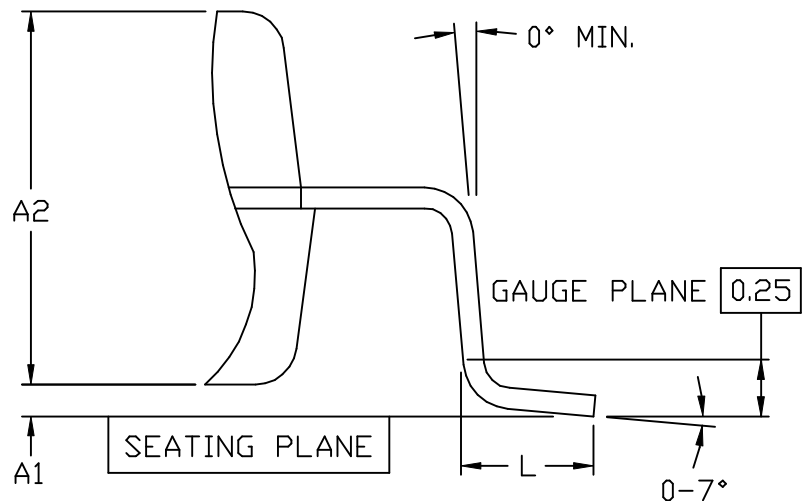


NOTES:


1. DIMENSIONS D1 AND E1 INCLUDE MOLD MISMATCH, BUT DO NOT INCLUDE MOLD PROTRUSION; ALLOWABLE PROTRUSION IS 0.25 MM PER SIDE.
2. DETAILS OF PIN 1 IDENTIFIER ARE OPTIONAL BUT MUST BE LOCATED WITHIN THE ZONE INDICATED.
3. ALLOWABLE DAMBAR PROTRUSION IS 0.08 MM TOTAL IN EXCESS OF THE B DIMENSION; PROTRUSION NOT TO BE LOCATED ON LOWER RADIUS OR FOOT OF LEAD.

DIM	MIN	MAX
A	—	1.60
A1	0.05	—
A2	1.35	1.45
B	0.17	0.27
C	0.09	0.20
D	21.80	22.20
D1	20.00	BSC
E	15.80	16.20
E1	14.00	BSC
e	0.50	BSC
L	0.45	0.75



DETAIL A

DIMENSIONS ARE IN MILLIMETERS

SIGNATURE		DATE		 <b>Dallas Semiconductor</b> TITLE MARKETING OUTLINE, 128 LD. LQFP, 14X20 MM BODY, 1.00 FORM, 1.4 MM THICK			
DOC. CONTROL:							
ENGR. MGR:							
MFG. ENGR:							
CHECKED BY:							
DRAWN BY:		SIZE A	FSCM NO	PART NO.		REV B	
DO NOT SCALE DWG.			SCALE N/A		SHEET 1 OF 1		